



## **Cohu's Semiconductor Equipment Group Receives Multi-Unit Order for Next Generation T-Core Thermal Subsystem**

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POWAY, Calif.--(BUSINESS WIRE)--Jul. 15, 2013-- Cohu, Inc. (NASDAQ:COHU) today announced a multi-unit order for T-Core thermal subsystems that optimize testing of application processors used in mobile computing.

The company's T-Core thermal technology enables higher test yield for ICs that power a wide range of smartphones, tablets, and other consumer devices. T-Core can be integrated in Cohu's production test handlers or in batch test systems for cost-effective, parallel testing of hundreds of ICs.

"We are pleased to see our thermal technology that is today the benchmark for testing mid and high power processors, being used in new applications for the mobile market," said Luis Müller, President of Cohu's Semiconductor Equipment Group.

Cohu's thermal technology optimizes test yield of high-end devices, including microprocessors used in laptops, PCs and cloud-servers, as well as graphic processors, mobile application processors and a variety of other complex ICs. T-Core reflects Cohu's commitment to continued leadership in thermal technology to cost-effectively address evolving market requirements. Current T-Core configurations range from single to >500 devices tested in parallel at 8W to 350W power dissipation.

### **Forward Looking Statements:**

Certain matters discussed in this release, including statements concerning Cohu's new products and orders are forward-looking statements that are subject to risks and uncertainties that could cause actual results to differ materially from those projected or forecasted. Such risks and uncertainties include, but are not limited to, inventory write-downs, our ability to convert new products under development into production on a timely basis, support product development and meet customer delivery and acceptance requirements for next generation equipment, failure to obtain customer acceptance resulting in the inability to recognize revenue and accounts receivable collection problems, customer orders may be canceled or delayed, the concentration of our revenues from a limited number of customers, our reliance on patents and intellectual property, compliance with U.S. export regulations, and the cyclical and unpredictable nature of capital expenditures by semiconductor manufacturers. These and other risks and uncertainties are discussed more fully in Cohu's filings with the Securities and Exchange Commission, including the most recently filed Form 10-K and Form 10-Q. Cohu assumes no obligation to update the information in this release.

### **About Cohu:**

Cohu is a supplier of test handling, burn-in, thermal subsystems and MEMS test solutions used by the global semiconductor industry as well as a supplier of microwave communications and video equipment.

For press releases and other information of interest to investors, please visit Cohu's website at [www.cohu.com](http://www.cohu.com).



Source: Cohu, Inc.

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